04 11	1 - 2006 LIS DEPARTMENT OF COMMERCE	
(Rev. 10/02) U.S. Patent and Trademark Office OMB No. 0651-0027 (exp. 6.30.2005)		
103215442		
To the Honorable Commissioner of Patents and Trademarks: I 1. Name of conveying party(ies):	Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies)	
	Name: Taiwan Semiconductor Manufacturing	
Ker-Min Chen	Co., Ltd.	
Additional name(s) of conveying party(ies) attached? Yes No	Internal Address:	
Nature of conveyance:	- 100 milernal Address. 200	
	_	
☐ Security Agreement ☐ Change of Name	Street Address: No. 8, Li-Hsin Road 6	
□ Other	Science Based Industrial Park	
Execution Date: March 27, 2006	City: Hsin-Chu State: Taiwan Zip: 300-77	
i i	Additional name(s) & address(es) attached?	
	□ Yes ☒ No	
Application number(s) or patent number(s):		
If this document is being filed together with a new application, the execution date of the application is: 04/04/06		
A. Patent Application No.(s)	B. Patent No.(s)	
Additional numbers attached? ☐ Yes ☒ No		
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: <u>Howard Chen, Esq.</u>	7. Total fee (37 CFR 3.41)\$ 40.00	
Internal Address:		
	X Enclosed	
	Authorized to be charged to deposit account	
Street Address: Preston Gates & Ellis LLP		
55 Second Street, Suite 1700		
City: San Francisco State: CA Zip: 94105	8. Deposit account number:	
5/1). <u></u>	50-3414	
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9. Signature:		
Ting-Mao Chao, Esq., Aug line 4/4/06		
Ltd. Recog. No. L0119 Signal		

Total number of pages including cover sheet, attachments, and documents: 3 Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

(4/06/2006]JUHARI | 00000012 113972 < FO:8021

Name of Person Signing

Express Mail Label No. EV 789544359 Attorney Reference: 52604-00128

ASSIGNMENT AND AGREEMENT

For value received, I/we Ker-Min Chen, hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest. for the United States of America, in and to certain inventions related to DUAL VOLTAGE SINGLE GATE OXIDE I/O CIRCUIT WITH HIGH VOLTAGE STRESS TOLERANCE described in an application for Letters Patent of the United States with ____, 2006 and all the rights April 4 filed on and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions. I/We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all

application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

Assignment and Agreement - Page 1

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I/We agree that, when requested, I/we shall, without charge to **Taiwan**Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1:	
Dated: 3/27/2006	Ker-Min Chen
Ker-Min Chen	
Mailing and Residence: 5F., No	1, Alley 7, Lane 384 Ser. 1.
Thoughua Rd., Hernchu City 300 Taiwan (R.O.C)	
Citizenship: Taiwan (R.O.C	

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PATENT REEL: 017717 FRAME: 0015

RECORDED: 04/04/2006